

Introduction

The purpose of this application note is to describe the evaluation boards for either the HI3026 or HI3026A 8-bit ultra high speed analog to digital converters (ADC). The main difference between the two devices is the maximum conversion speed of 120 MSPS and 140 MSPS respectively. This document will use HI3026 for both devices. The boards are shipped with the device soldered onto the PCB. The evaluation board includes many discrete components along with op amps, buffers, logic level conversion (ECL to TTL and TTL to ECL) and a 10-bit D/A converter for reconstructing the output of the HI3026. After latching the HI3026, input data with a frequency divided clock, the analog signal can be regenerated by a 10-bit high speed D/A converter. The latched data can also be extracted externally via a 24 pin cable connector.

Board Description

The evaluation platform is a two layer board optimized for high frequency operation. The supplies to the board should be low noise clean regulated linear power supplies. To ensure reliable performance, use the recommended operating conditions and never exceed the absolute maximum ratings shown in Table 1 and Table 2.

The signals in and out of the board are defined in the Pin Description table, which details various connectors and their function.

TABLE 1. OPERATING CONDITIONS

	MIN (V)	TYP (V)	MAX (V)
SUPPLY VOLTAGE			
V _{CC}	4.75	5.0	5.25
GND	-	0	-
V _{EE}	-5.50	-5.0	-4.75
+Amp	+3	+5	+7
-Amp	-7	-5	-3
(+AMP)-(-AMP)	9	10	11
ANALOG INPUT			
AMP.IN	-0.75	0	1.05
DIR.IN (V _{P-P})	1.5	2.0	2.2
CLOCK INPUT			
CLK.IN (V _{P-P})	0.75	0	1.05

TABLE 2. ABSOLUTE MAXIMUM RATINGS

	MIN (V)	MAX (V)
SUPPLY VOLTAGE		
V _{CC}	-0.5	7.0
V _{EE}	-7.0	0.5
+Amp	-0.5	7.0
-Amp	-7	0.5

Typical Performance Curves (HI3026A)

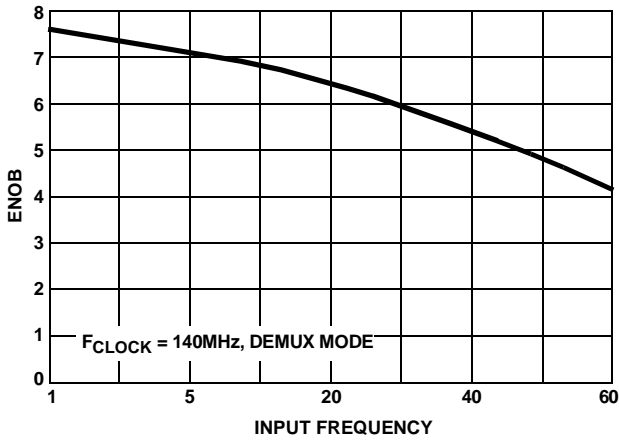


FIGURE 1. ENOB vs F_{IN}

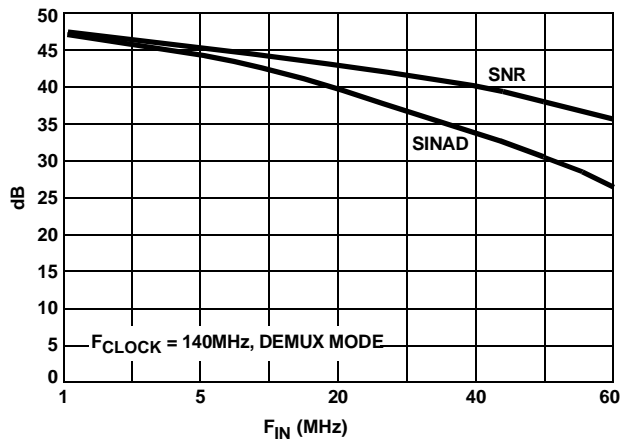


FIGURE 2. SINAD AND SNR

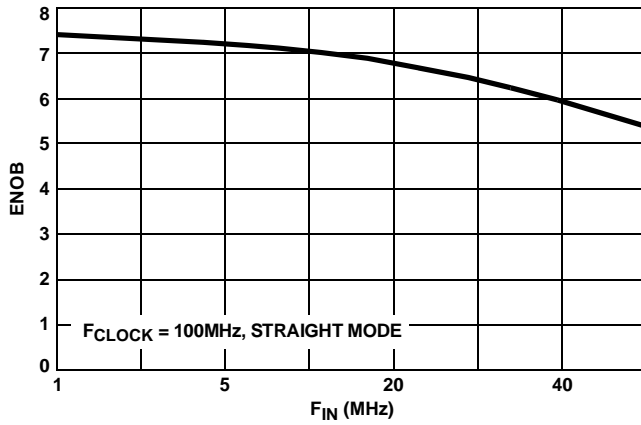


FIGURE 3. ENOB vs F_{IN}

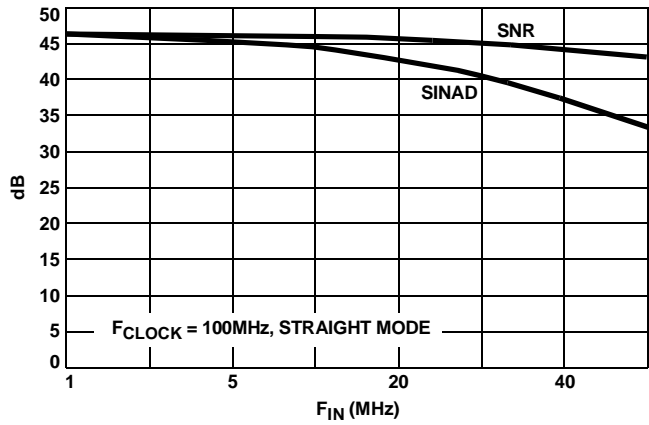


FIGURE 4. SINAD AND SNR

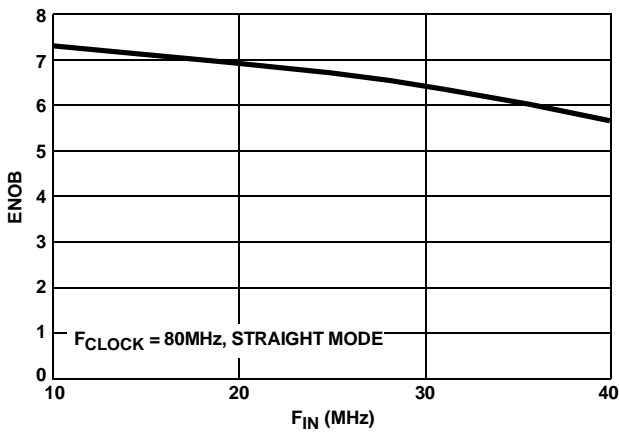


FIGURE 5. ENOB vs F_{IN}

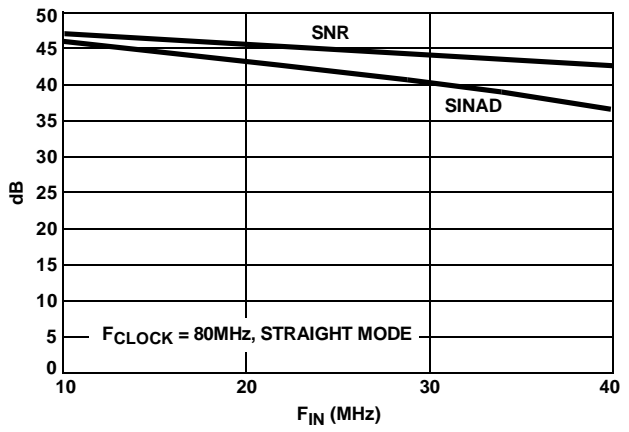
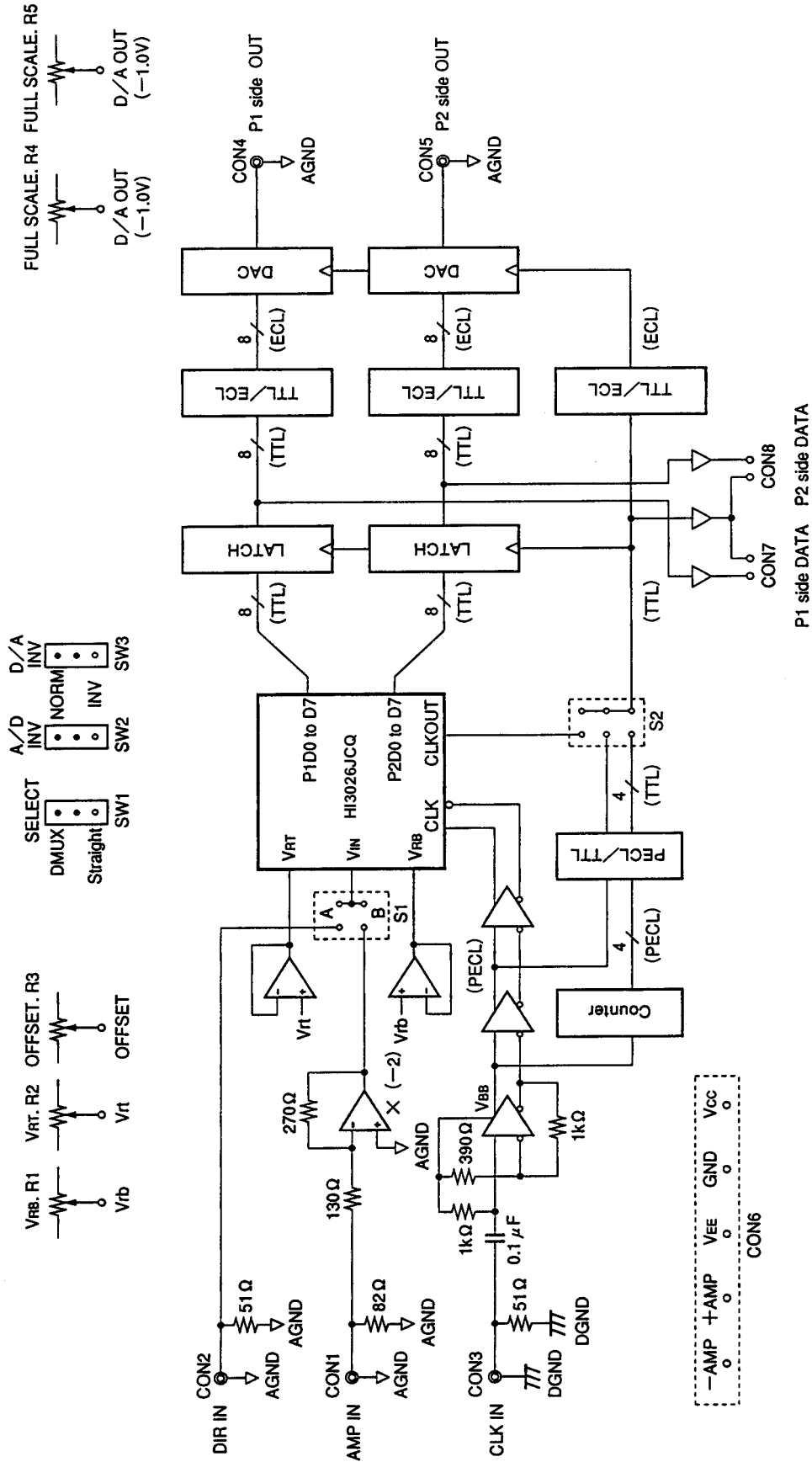


FIGURE 6. SINAD AND SNR

Pin Descriptions

PIN NO.	SYMBOL	I/O	STANDARD I/O LEVEL	CURRENT	DESCRIPTION	
CON1	AMP.IN	I	0.95Vp-p		Doubles the analog input signal amplitude using the operational amplifier. The input impedance is 50Ω.	
CON2	DIR.IN	I	2.0Vp-p		AC coupling input. suitable for sine waves and other repeating waveforms. The input impedance is 50Ω.	
CON3	CLK.IN	I	1.0Vp-0		The HI3026 operates at the PECL level clock using the sine wave-to-PECL conversion circuit. The input impedance is 50Ω.	
CON4	P1 Side OUT	O	0 to -1V		Allows the D/A converted waveform of the HI3026, port 1 side data to be observed. The output impedance is 50Ω.	
CON5	P2 Side OUT	O	0 to -1V		Allows the D/A converted waveform of the HI3026, port 2 side data to be observed. The output impedance is 50Ω.	
	V _{CC}	I	5.0V	0.8A	The inside of the board is divided into analog and digital systems.	
	GND	I	0V			
	V _{EE}	I	-5.0V	-0.6A		
	+AMP	I	5.0V	40mA		+ side power supply for the operation amplifier.
	-AMP	I	-5.0V	-40mA		- side power supply for the operation amplifier.
CON7	P1 side DATA	O	TTL		The HI3026, port 1 side data output is latched at the frequency divided clock and then output.	
CON8	P2 side DATA	O	TTL		The HI3026, port side data output is latched at the frequency divided clock and then output.	

Block Diagram



Board Adjustments and Settings

1. VRB.R1: HI3026, VRB voltage adjusting volume.
2. VRT.R2: HI3026, VRT voltage adjusting volume.
3. OFFSET.R3: Adjusting volume for matching the AMP.IN input and DIR.IN input signal ranges to the HI3026, input range.
4. FULL SCALE.R4: Full-scale adjusting volume for the port 1 D/A output. (-1V: Typ.)
5. FULL SCALE.R5: Full-scale adjusting volume for the port 2 D/A output. (-1V: Typ.)
6. S1: Switching junction for the dual analog input pins.
Set as follows according to the input pins used.

SYMBOL	JUNCTION	
	A	B
AMP.IN	OPEN	SHORT
DIR.IN	0.1 μ F	10k Ω

7. S2: Setting junction for the clock frequency division ratio. The operating speed after latching is determined by the frequency division ratio set here.
When set to CLK OUT, it operates according to the HI3026, clock output.
8. SW1 SELECT: HI3026, output mode selector switch.
9. SW2 A/D INV: HI3026, output polarity inversion switch.
10. SW# D/A INV: D/A converter output polarity inversion switch.

Notes on Board Operation

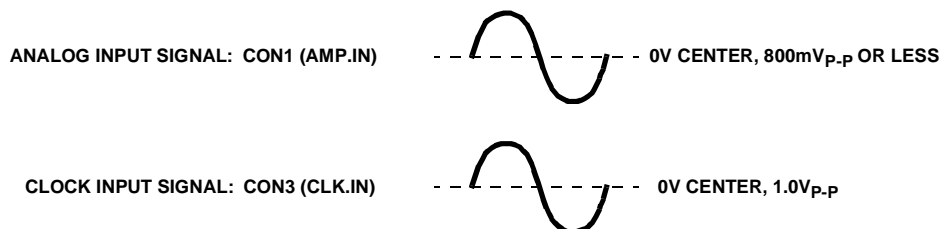
1. The factory settings for the HI3026, Evaluation Board are as follows:

VRB.R1 = 1.5V	FULL SCALE.R4 = -1V	S1 A...OPEN, B ...SHORT S2 8...SHORT (1/8 frequency division)
VRT.R2 = 3.0V	FULL SCALE.R5 = -1V	
OFFSET.R3 = 2.25V		

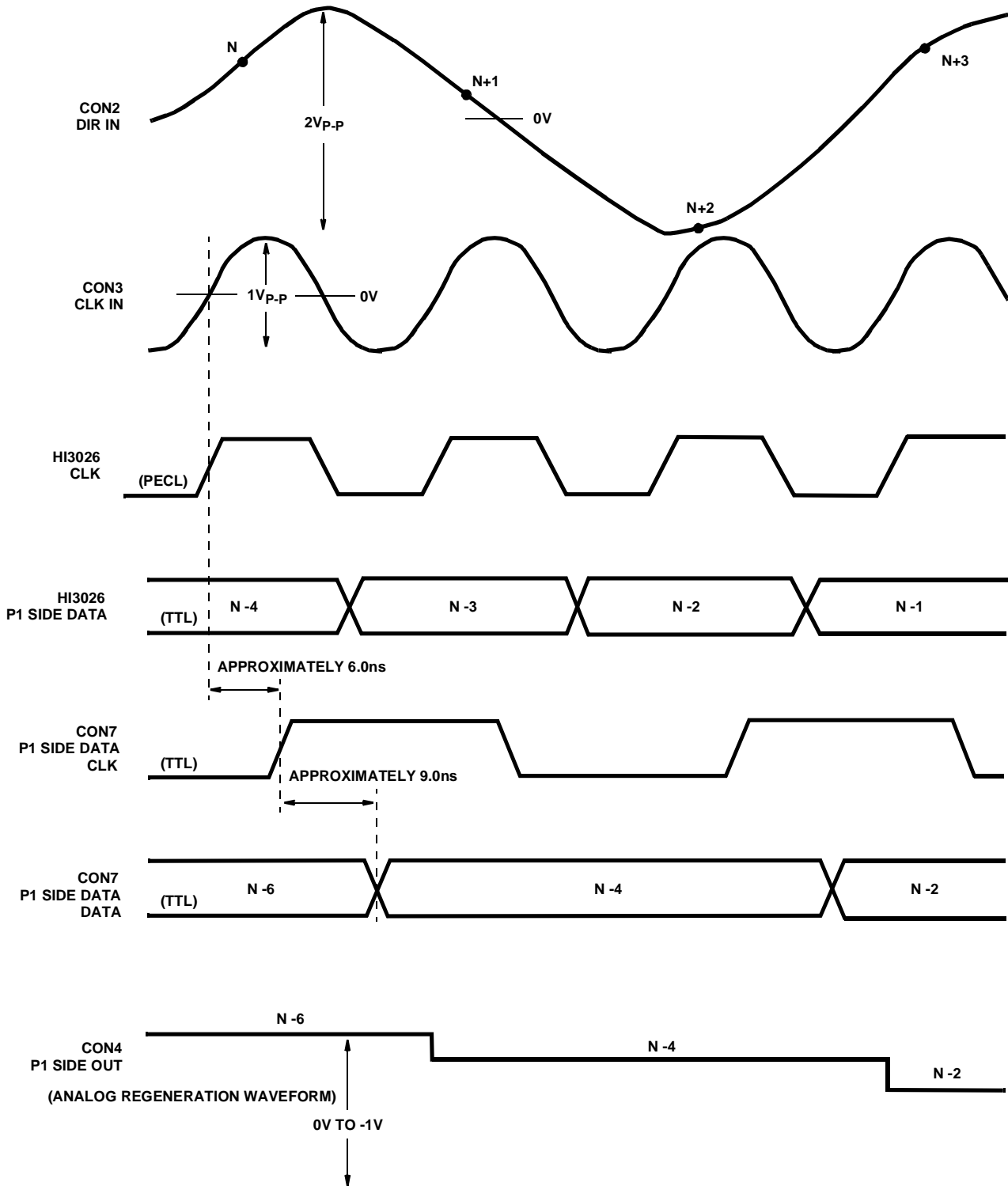
When using the board in this condition, the input signals should be input at the amplitudes shown below.
(The frequency is set as desired.)

2. When the analog signal is input from the CON1 (AMP.IN) pin, IC2:CLC404 limits the input dynamic range of the A/D converter's analog input signal according to the +AMP and -AMP supply voltages. The power supply for the operational amplifier can also be shifted to +AMP = +7.0V and -AMP = -3.0V to allow use with a wider input dynamic range.

3. When the analog input signal is a sine wave or other repeating waveform, the signal can be input from the CON2 (DIR.IN) pin with AC coupling. In these cases, the input dynamic range is not limited by the +AMP and -AMP supply voltages, but the VRT level may be limited by IC3:NJM3403A. Therefore, the power supply for the operational amplifier should be shifted in the same manner as in 2. above.
4. In the evaluation board of the HI3026, CLC404 (Comlinear) is employed for IC2 to drive the analog input signal. Though, CLC505 (Comlinear) can also be used instead of CLC404, there should be little change in the peripheral circuit in this case.



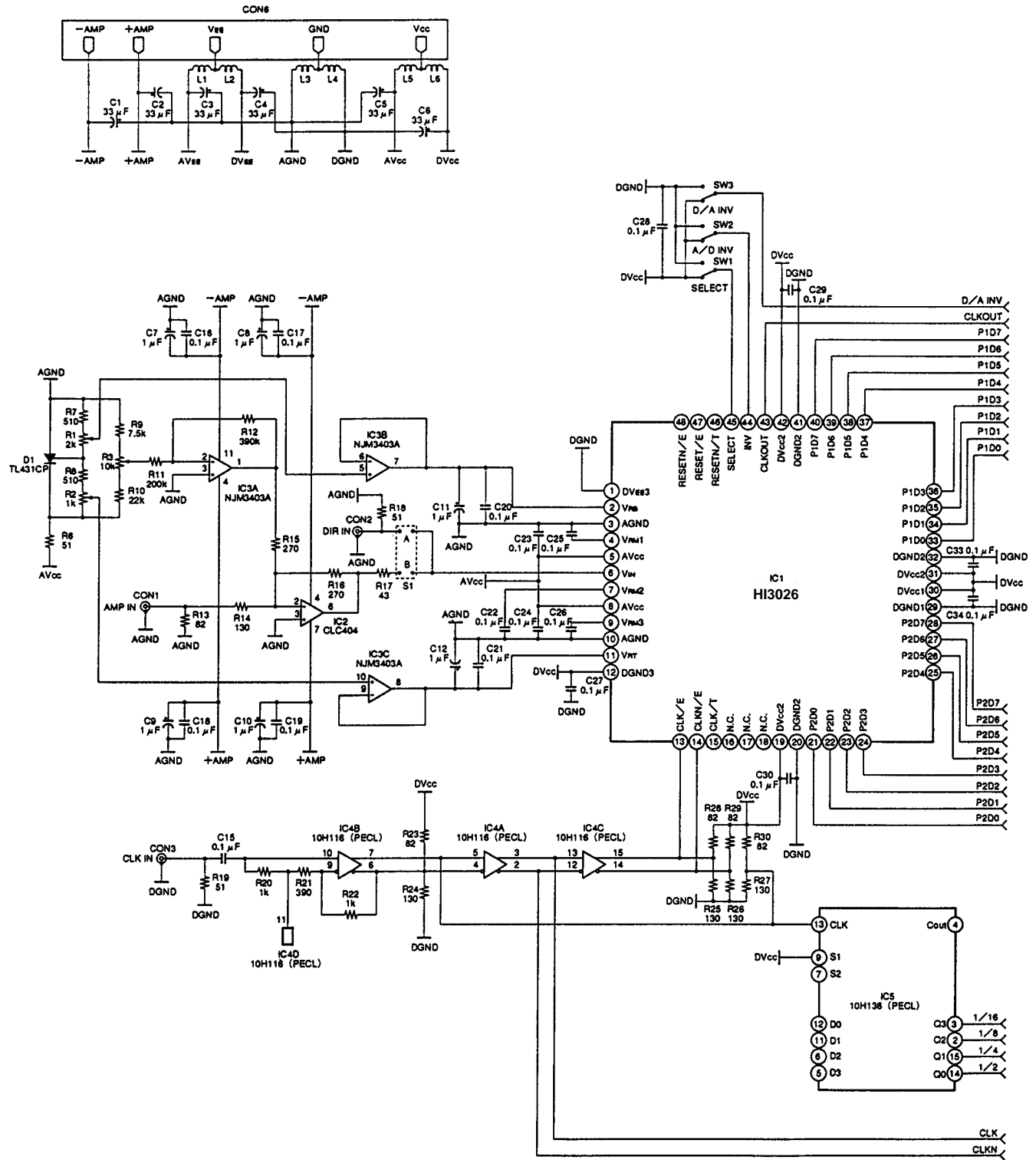
Timing Diagram



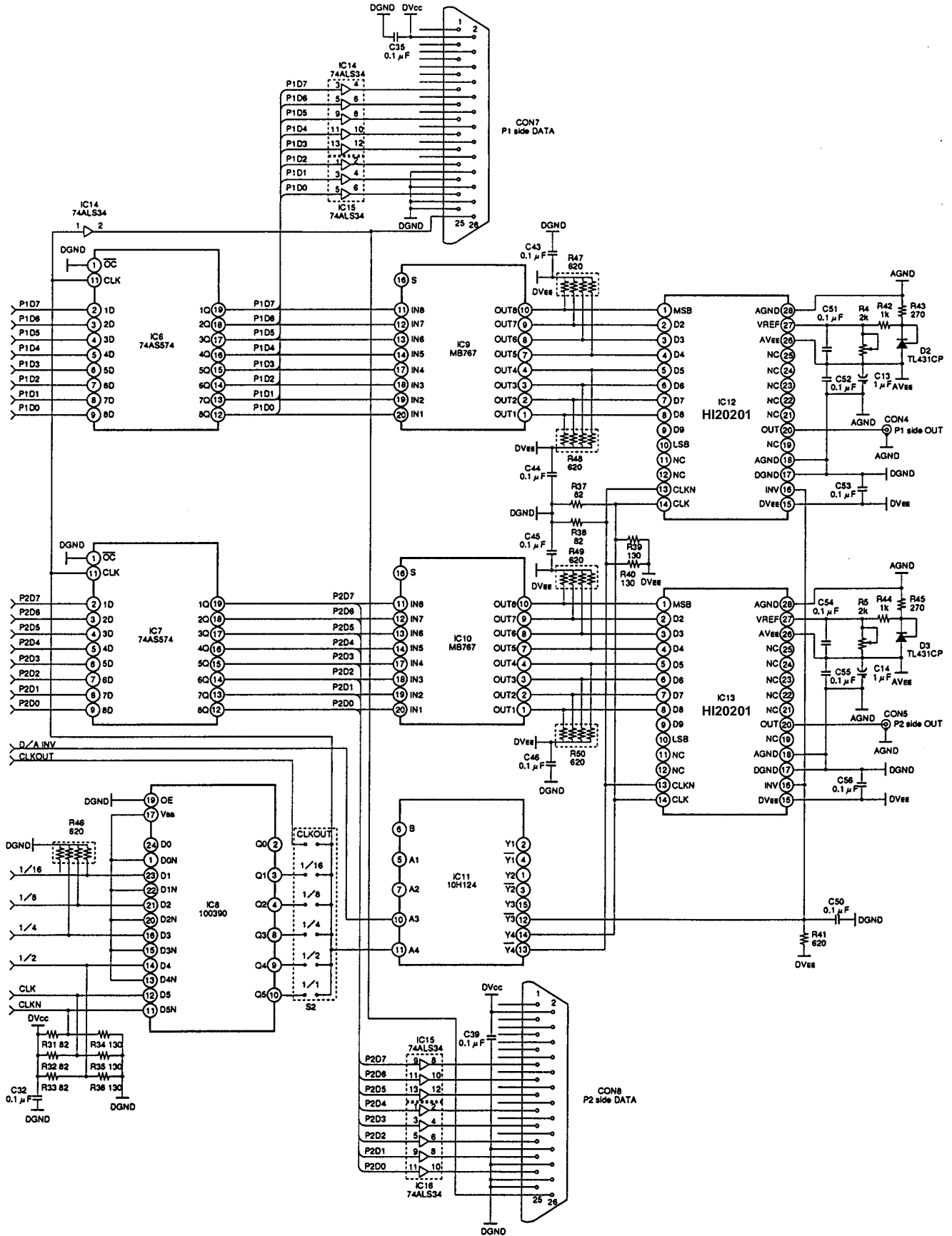
OPERATING CONDITIONS

HI3026 OPERATING MODE : STRAIGHT MODE
 ANALOG INPUT : DIR IN PIN INPUT
 S2 SETTING : 1/2 FREQUENCY DIVIDED CLOCK

Schematic Diagram



Schematic Diagram (Continued)



Application Note 9652

Component List

NO.	PRODUCT NAME	FUNCTION	NO.	PRODUCT NAME	FUNCTION
IC1	HI3026	8-bit A/D converter	R2	RJ-5W-1K	1k Ω volume resistor
IC2	CLC404AJE	OP-AMP	R1, 4, 5	RJ-5W-2K	2k Ω volume resistor
IC3	NJM3403AM	OP-AMP	R3	RJ-5W-10K	10k Ω volume resistor
IC4	MC10H116L	ECL buffer	R46 to 50	RGLD4X621J	620 Ω network resistor
IC5	MC10H136L	ECL Counter			
IC6, 7	74AS574N	TTL Latch	R6, 18, 19	FRD-25SR (0.25W)	51 Ω
IC8	100390	PECL \rightarrow TTL conversion	R7, 8	FRD-25SR (0.25W)	510 Ω
IC9, 10	MB767P	TTL \rightarrow ECL conversion	R9	FRD-25SR (0.25W)-	7.5k Ω
IC11	MC10H124L	TTL \rightarrow ECL conversion	R10	FRD-25SR (0.25W)	22k Ω
IC12, 13	HI20201JCB	10-bit D/A converter	R11	FRD-25SR (0.25W)	200k Ω
IC14 to 16	74ALS34	TTL Buffer	R12	FRD-25SR (0.25W)	390k Ω
D1 to 3	TL431CP	Shunt regulator	R13, 23 28 to 33, 37, 38	FRD-25SR (0.25W)	82 Ω
SW1 to 3	ATE1D-2F3-10	Toggle switch	R14, 24 to 27, 34 to 36, 39, 40	FRD-25SR (0.25W)	130 Ω
S1, 2	JX-1	Short pin	R15, 16, 43, 45	FRD-25SR (0.25W)	270 Ω
CON1 to 5	01K0315	BNC connector	R17	FRD-25SR (0.25W)	43 Ω
CON6	TJ-563	Power supply connector	R20, 22, 42, 44	FRD-25SR (0.25W)	1k Ω
CON7, 8	(FAP-2601-1202)	Flat cable connector	R21	FRD-25SR (0.25W)	390 Ω
L1 to 6	ZBF503D-00	Ferrite-bead filter	R41	FRD-25SR (0.25W)	620 Ω
C1 to 6	Tantal capacitor	33 μ F			
C7 to 12	Tantal capacitor	1 μ F			
C15	Ceramic capacitor	0.1 μ F			
All parts other than those listed above					
	Chip capacitor	0.1 μ F			

NOTE: CON7 and 8 are not mounted when boards are shipped. (Manufacturer: YAMAICHI Electronics Co., Ltd.)

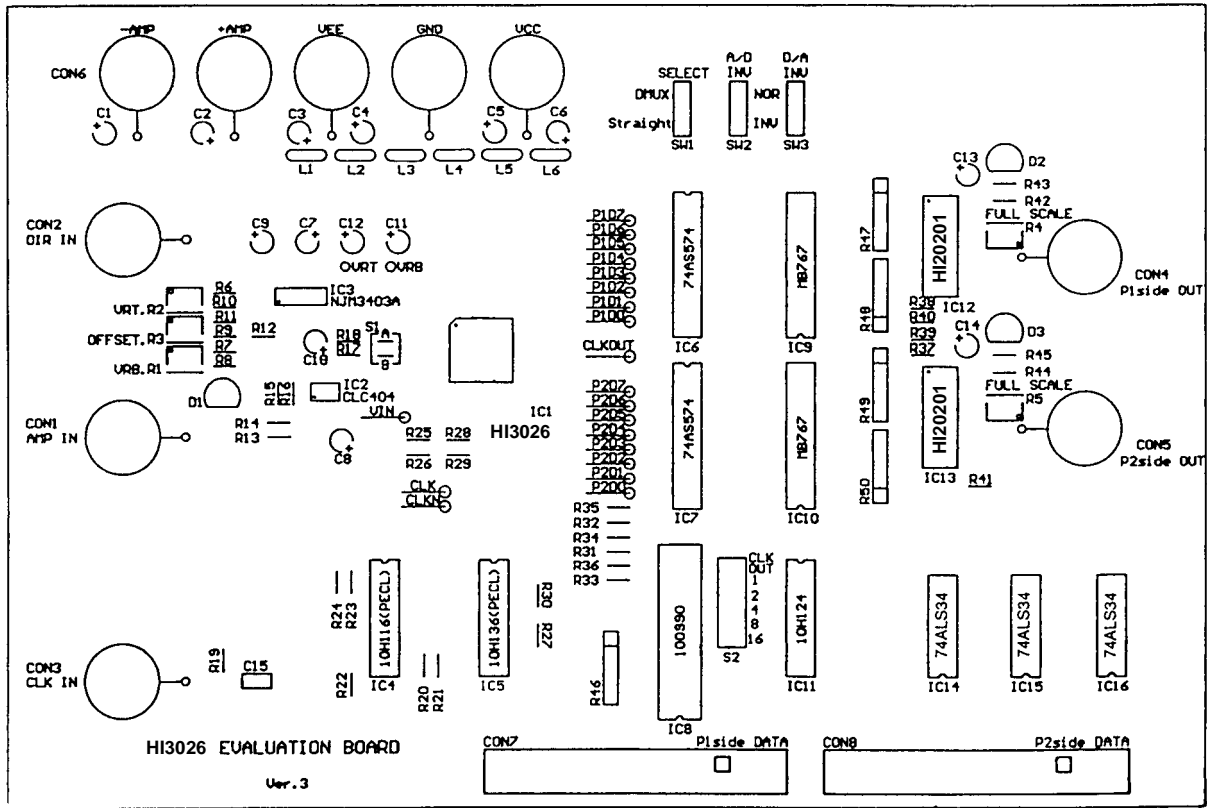


FIGURE 7. COMPONENT SIDE SILK DIAGRAM

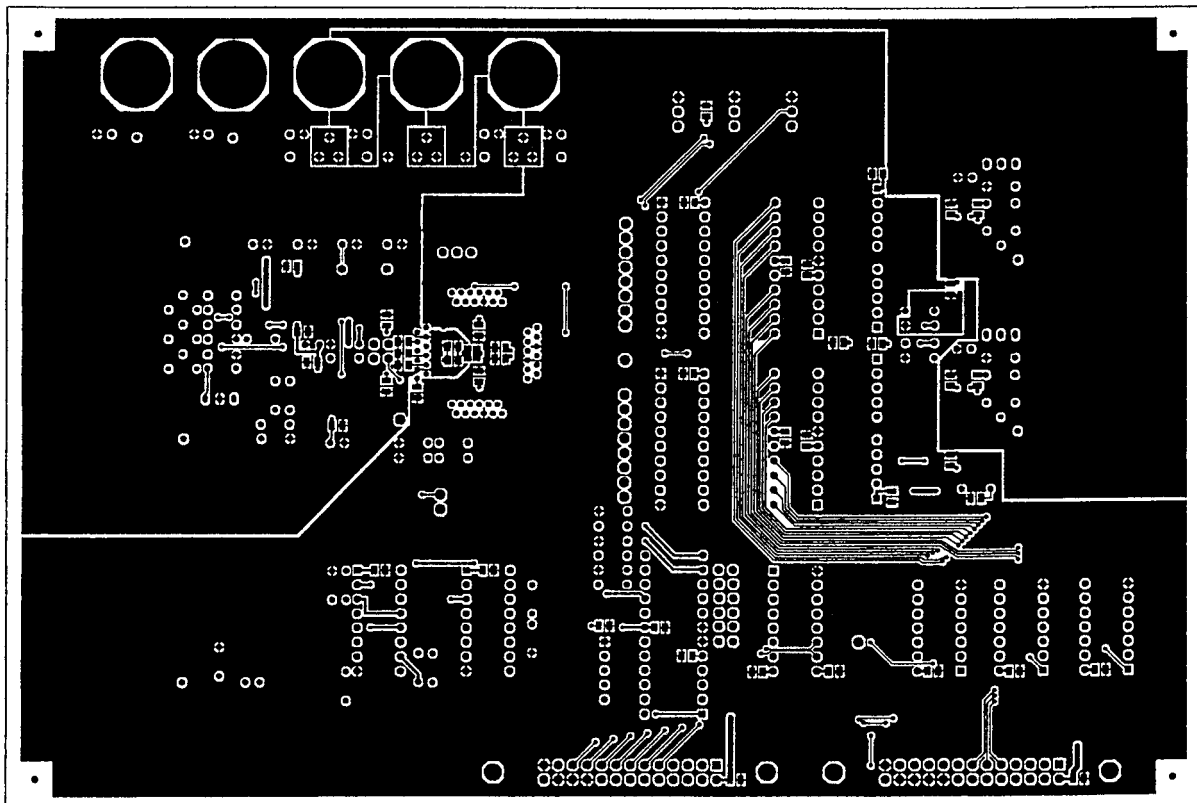


FIGURE 9. SOLDER SIDE SILK DIAGRAM

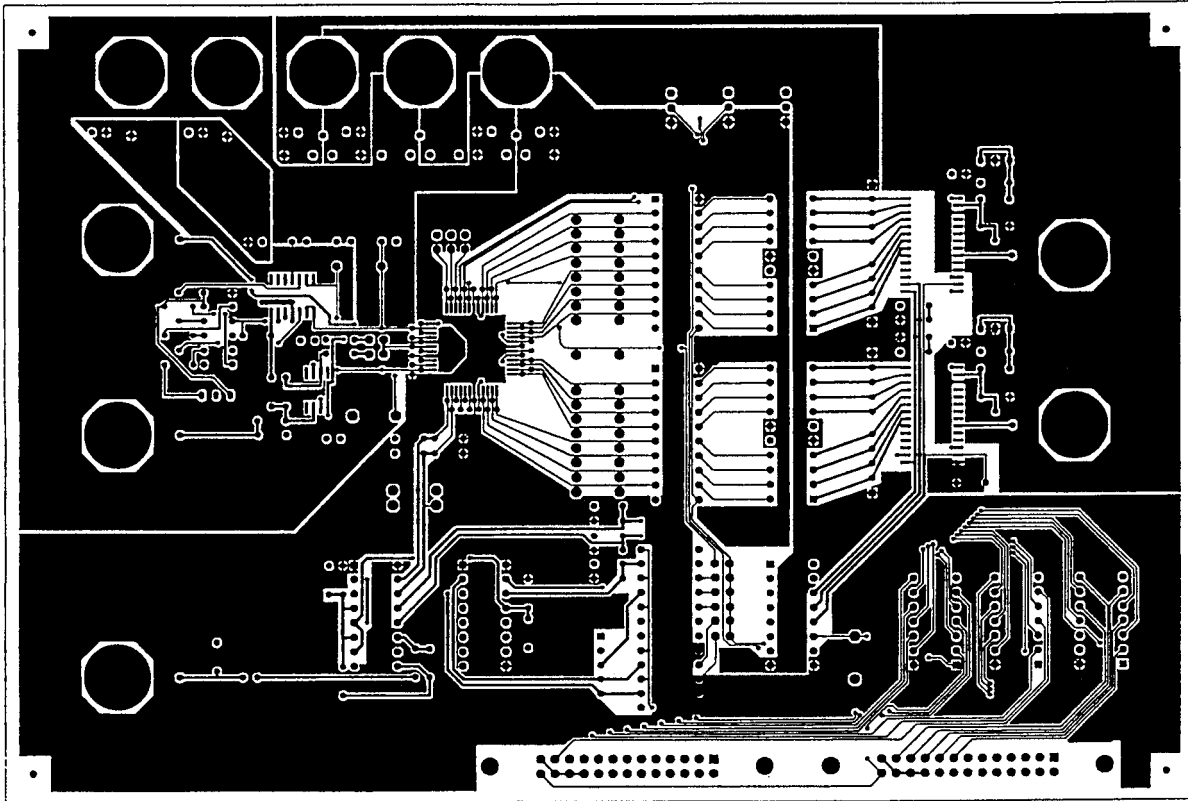


FIGURE 8. COMPONENT SIDE PATTERN DIAGRAM

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